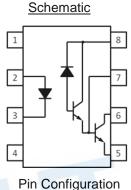
DATASHEET

8 PIN DIP LOW INPUT CURRENT HIGH GAIN SPLIT DARLINGTON PHOTOCOUPLER 6N138 6N139



Features

- High current transfer ratio-2000% typical
- High isolation voltage between input and output (Viso=5000 Vrms)
- Guaranteed performance from 0°C to 70°C
- Pb free and RoHS compliant.
- UL and cUL approved(No. E214129)
- VDE approved (No. 132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved



1. No Connection 2. Anode

- 3. Cathode
- 4. No Connection 5. Gnd
- 5. GI

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- 6. V_{out} 7. V_B
- 8. Vcc

Description

The 6N138 and 6N139 devices each consists of an infrared emitting diode, optically coupled to a high gain split Darlington photo detector. They provide extremely high current transfer ratio between input and output, with access to a base terminal to adjust the gain bandwidth. These devices are packaged in an 8-pin DIP package and available in wide-lead spacing and SMD options.

Applications

- Digital logic ground isolation
- RS-232C line receiver
- Low input current line receiver
- Microprocessor bus isolation
- Current loop receiver

Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Rating	Unit	
Forward current		l _F	20	mA	
Peak forward current (50% duty, 1ms P.W)		IFP	40	mA	
Peak transient Current (≤1µs P.W,300pps)		I _{Ftrans}	1	А	
Reverse voltage		VR	5	V	
Power dissipation		P _{IN}	45	mW	
Power dissipation Output current Emitter-Base Reverse Output Voltage		Po	100	mW	
		lo	60	mA	
		V _{ER}	0.5	V	
Output voltage	6N138 6N139	Vo	-0.5 to 7 -0.5 to 18	V	
Supply voltage		Vcc	-0.5 to 7 -0.5 to 18	V	
Isolation voltage *1		VISO	5000	V rms	
Operating temperature		T _{OPR}	-40 ~ +85	°C	
Storage Temperature		T _{STG}	-55 ~ +125	°C	
Soldering temperature *2		T _{SOL}	260	°C	
9	Forward current Peak forward current (50% duty, 1ms P.W) Peak transient Current (≤1µs P.W,300pps) Reverse voltage Power dissipation Power dissipation Output current Emitter-Base Reverse Voltage Output voltage Supply voltage oltage *1 temperature emperature	Forward current Peak forward current (50% duty, 1ms P.W) Peak transient Current (≤1µs P.W,300pps) Reverse voltage Power dissipation Power dissipation Output current Emitter-Base Reverse Voltage Output voltage 6N138 6N139 Supply voltage 6N139 oltage *1 temperature	Forward currentIFPeak forward current (50% duty, 1ms P.W)IFPPeak transient Current ($\leq 1\mu s$ P.W, 300pps)IFtransReverse voltageVRPower dissipationPINPower dissipationPOOutput currentIoEmitter-Base Reverse VoltageVEROutput voltage $\frac{6N138}{6N139}$ VoSupply voltage $\frac{6N138}{6N139}$ Vccoltage *1VISOVISOtemperatureTOPRemperatureTSTG	Forward currentIF20Peak forward current (50% duty, 1ms P.W)IFP40Peak transient Current (s1µs P.W,300pps)IFtrans1Reverse voltage V_R 5Power dissipation P_{IN} 45Power dissipation P_0 100Output currentIo60Emitter-Base Reverse V_{ER} 0.5Output voltage $\frac{6N138}{6N139}$ V_{OC} -0.5 to 7 -0.5 to 18Supply voltage $\frac{6N138}{6N139}$ V_{CC} -0.5 to 18otage '1 V_{ISO} 5000100temperature T_{OPR} -40 ~ +85emperature T_{STG} -55 ~ +125	

Notes:

*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2, 3, 4 are shorted together, and pins 5, 6, 7, 8 are shorted together.

*2 For 10 seconds

Electrical Characteristics (T_A=0 to 70°C unless specified otherwise Input

mput								
Parameter		Symbol	Min.	Тур.	Max.	Unit	Condition	
Forward voltage		VF	-	1.3	1.7	V	I _F = 1.6mA	
Reverse Voltage		VR	5.0	-	-	V	I _R = 10μΑ, Τ _Α =25°C	
Temperature coefficient of forward voltage		$\Delta V_{F} / \Delta T_{A}$	-	-1.8	-	mV/°C	I _F =1.6mA	
Output								
Parameter		Symbol	Min	Тур.	Max.	Unit	Condition	
Logic High	6N138	- Iou -	-	0.01	100	- μΑ	I _F =0mA,	
Output Current	6N139	– I _{ОН} –	-	-	250		Vo=Vcc=18V	
Logic Low	6N138			0.6	1.5	mA	I _F =1.6mA, V _O =Open,	
Supply Current	6N139	- Iccl	-	0.0	1.5		V _{CC} =18V	
Logic High	6N138		_	0.05	10	μA	I _F =0mA, V _O =Open,	
Supply Current	6N139	– Іссн	-	0.05	10	μΑ	V _{CC} =18V	

Transfer Characteristics (T_a=0 to 70°C unless specified otherwise, Vcc=4.5V)

Parameter		Symbol	Min	Тур.	Max.	Unit	Condition
Current Transfer Ratio	6N139		400	2500	-		$I_F = 0.5 \text{mA}, V_O = 0.4 \text{V}, V_{CC} = 4.5 \text{V}$
		CTR	500	2000	-	%	$I_F = 1.6 mA$, $V_O = 0.4 V$,
	6N138	-	300	2000	-		V _{CC} =4.5V
Logic Low Output Voltage	6N139		-	0.05	0.4	V	$I_F = 0.5 \text{mA}, I_O = 2 \text{mA}, V_{CC}=4.5 \text{V}$
		Vol	-	0.09	0.4		$I_F = 1.6mA, I_O = 8mA,$ $V_{CC}=4.5V$
			-	0.12	0.4		I _F = 5mA, I _O = 15mA, V _{CC} =4.5V
			-	0.17	0.4		$I_F = 12mA, I_O = 24mA, V_{CC}=4.5V$
	6N138		-	0.06	0.4		$I_F = 1.6mA$, $I_O = 4.8mA$, $V_{CC}=4.5V$

Switching Characteristics (T_a=0 to 70°C unless specified otherwise, Vcc=5V)

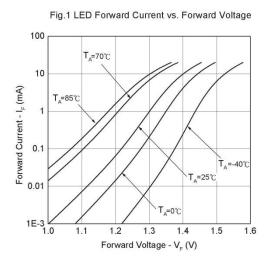
Parameter		Symbol	Min	Тур.	Max.	Unit	Condition
		_	-	5	25		$I_F = 0.5mA , R_L=4.7k\Omega, \\ T_A=25^{\circ}C$
	CN1400		-	-	30	μs	$I_F = 0.5 \text{mA}$, $R_L = 4.7 \text{k}\Omega$
Propagation Delay Time to	6N139	T _{PHL} -	-	0.2	1		$I_F = 12mA$, $R_L=270\Omega$, $T_A=25^{\circ}C$
Logic Low (Fig. 13)			-	-	2	he	$I_F = 12mA$, $R_L = 270\Omega$
(· · · · · · · · · · · · · · · · · · ·	6N138		-	1.4	10		$I_F = 1.6 \text{mA}$, $R_L=2.2 \text{k}\Omega$, $T_A=25^{\circ}\text{C}$
			-	-	15		$I_F = 1.6 \text{mA}$, $R_L = 2.2 \text{k}\Omega$
	6N139 6N138		-	16	60	μs	I_{F} = 0.5mA , RL=4.7kΩ, TA=25°C
		Трін	-	-	90		$I_F = 0.5 \text{mA}$, $R_L = 4.7 \text{k}\Omega$
Propagation Delay Time to			-	1.7	7		$I_F = 12mA$, $R_L=270\Omega$, $T_A=25^{\circ}C$
Logic High (Fig. 13)			-	-	10		$I_F = 12mA$, $R_L = 270\Omega$
(**3****)			-	8	35		$I_F = 1.6 \text{mA}$, $R_L=2.2 \text{k}\Omega$, $T_A=25^{\circ}\text{C}$
			-	-	50		$I_F = 1.6 \text{mA}$, $R_L = 2.2 \text{k}\Omega$
Common Mode Transient Immunity at Logic High (Fig. 14) ^{*3}		CM _H	1,000	ŀ	E	V/µs	I _F = 0mA , V _{CM} =10Vp-p, R _L =2.2KΩ, T _A =25°C
Common Mode Transient Immunity at Logic Low (Fig. 14) *3		CML	1,000	-	-	V/µs	I_F = 1.6mA , V _{CM} =10Vp-p, R _L =2.2KΩ, T _A =25°C

* Typical values at Ta = 25°C

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Typical Electro-Optical Characteristics Curves



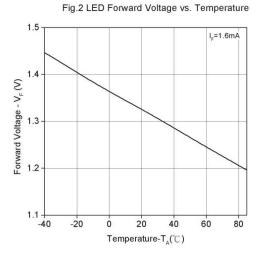


Fig.3 Output Current vs. Output Voltage

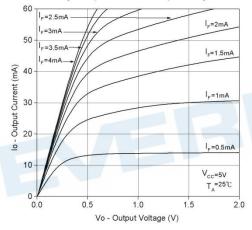


Fig.4 Output Current vs. Input Diode Forward Current

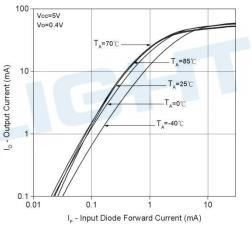


Fig.5 Current Transfer Ratio vs. Forward Current

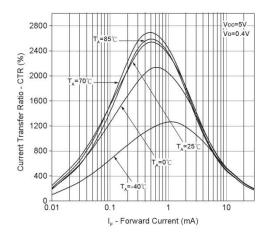
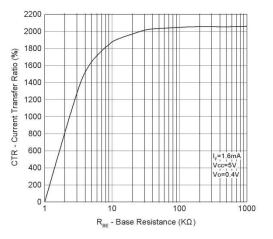


Fig.6 Current Transfer Ratio vs. Base-Emitter Resistance



vs. Load Resistance T_A=25°(100 T_f 10 Time - T (µs) 1 IF ADJUSTED ORV 0.1 1 10 R, - Load Resistance (KΩ)

Fig.7 Non-saturated Rise nand Fall Times

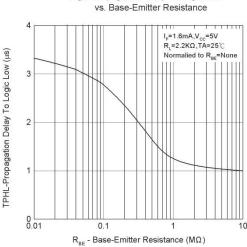
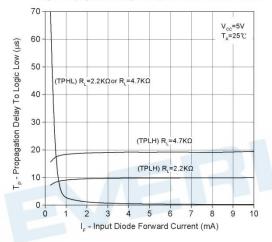


Fig.9 Propagation Delay vs. Input Diode Forward Current





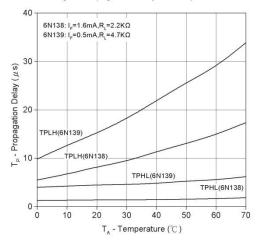


Fig.10 Propagation Delay to Logic Low vs. Pulse Period

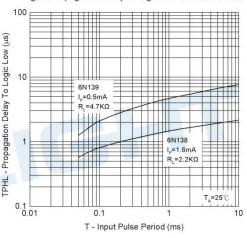


Fig.12 Logic Low Supply Current vs. Input Diode Forward Current

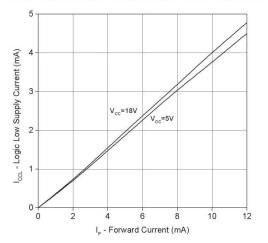
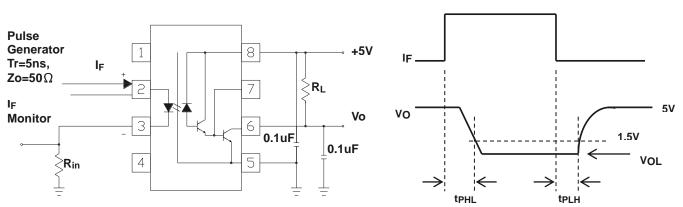


Fig.8 Propagation Delay To Logic Low

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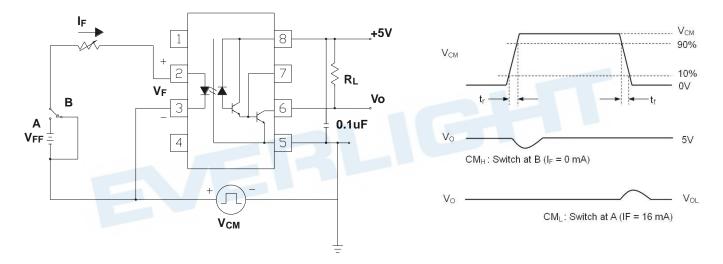
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Note:

*3 Common mode transient immunity in logic high level is the maximum tolerable (positive) dVcm/dt on the leading edge of the common mode pulse signal VCM, to assure that the output will remain in a logic high state (i.e., VO > 2.0V).

Common mode transient immunity in logic low level is the maximum tolerable (negative) dVcm/dt on the trailing edge of the common mode pulse signal, VCM, to assure that the output will remain in a logic low state (i.e., VO < 0.8V).



Order Information

Part Number



Note

- Х = Part No. (X = 8 or 9)
- = Lead form option (S, S1, M or none) Υ
- Ζ = Tape and reel option (TA, TB or none).
- V = VDE (optional)

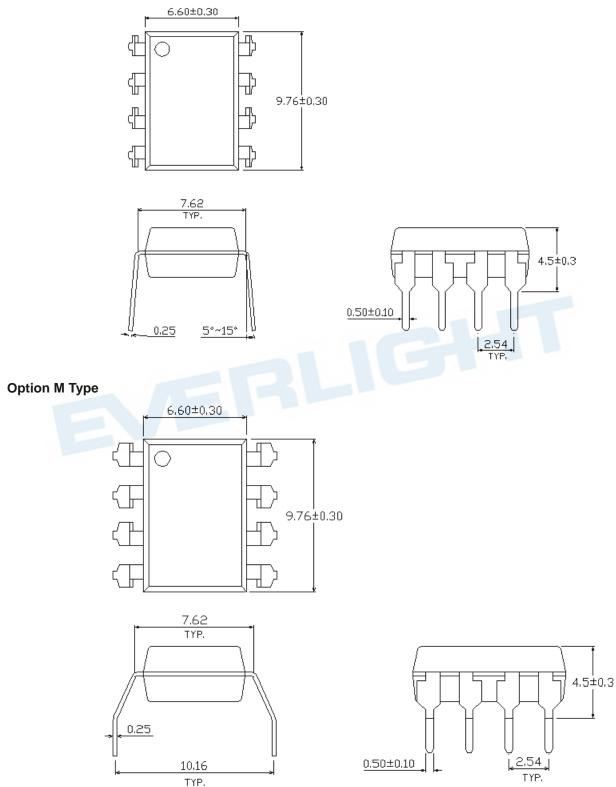
Option	Description	Packing quantity
None	Standard DIP-8	45 units per tube
М	Wide lead bend (0.4 inch spacing)	45 units per tube
S (TA)	Surface mount lead form + TA tape & reel option	1000 units per reel
S (TB)	Surface mount lead form + TB tape & reel option	1000 units per reel
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel
E	VERLIG	

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Package Dimension (Dimensions in mm)

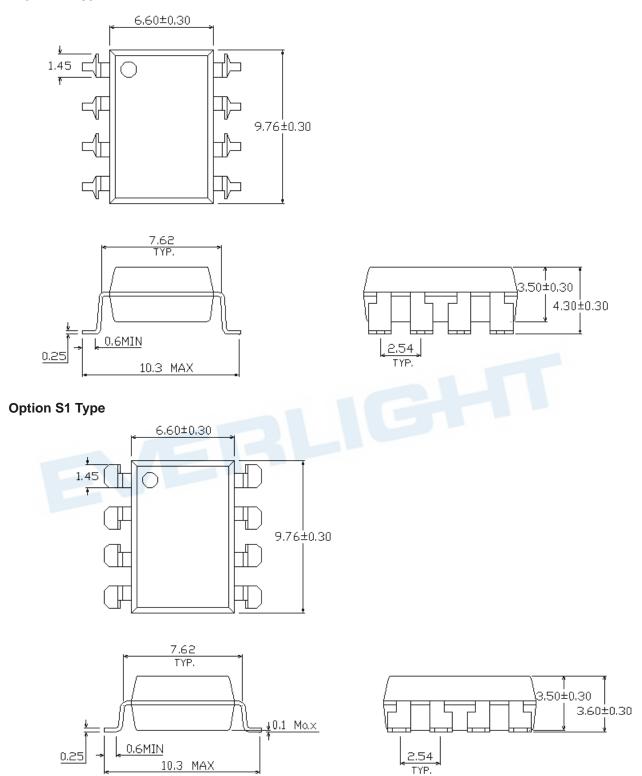
Standard DIP Type





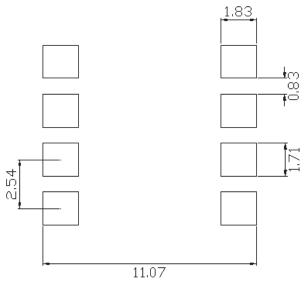


Option S Type





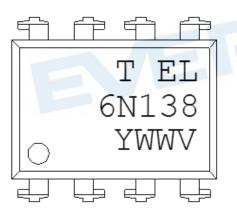
Recommended pad layout for surface mount leadform



Notes.

Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

Device Marking

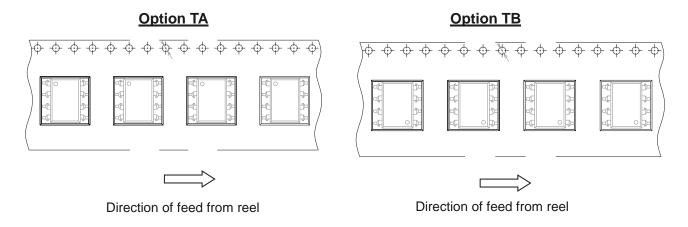


Notes

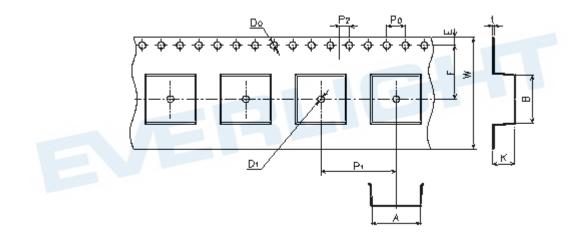
Т	denotes Factory
	No code : made in China
	T : made in Taiwan
EL	denotes EVERLIGHT
6N138	denotes Device Number
Y	denotes 1 digit Year code
WW	denotes 2 digit Week code
V	denotes VDE (optional)



Tape & Reel Packing Specifications



Tape dimension

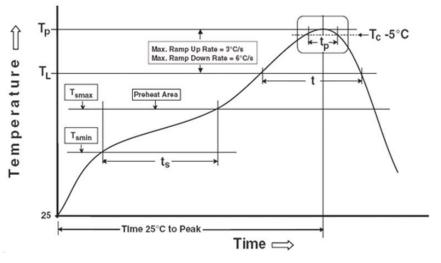


Dimension No.	А	В	Do	D1	E	F
Dimension(mm)	10.4±0.1	10.0±0.1	1.5+0.1/-0	1.5±0.25	1.75±0.1	7.5±0.1
Dimension No.	Ро	P1	P2	t	W	к
Dimension(mm)	4.0±0.1	12.0±0.1	2.0±0.05	0.4±0.05	16.0±0.3	4.5±0.1



Precautions for Use

- 1. Soldering Condition
 - 1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Preheat

Temperature min (T_{smin}) Temperature max (T_{smax}) Time (T_{smin} to T_{smax}) (t_s) Average ramp-up rate (T_{smax} to T_p)

Other

Liquidus Temperature (T_L) Time above Liquidus Temperature (t_L) Peak Temperature (T_P) Time within 5 °C of Actual Peak Temperature: T_P - 5°C Ramp- Down Rate from Peak Temperature Time 25°C to peak temperature Reflow times Reference: IPC/JEDEC J-STD-020D

150 °C 200°C 60-120 seconds 3 °C/second max

217 °C 60-100 sec 260°C 30 s 6°C /second max. 8 minutes max. 3 times

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